

Vishay Siliconix

P-Channel 30 V (D-S) MOSFET

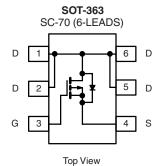
| PRODUCT SUMMARY | | | | |
|---------------------|------------------------------------|--------------------|--|--|
| V _{DS} (V) | R_{DS(on)} (Ω) | I _D (A) | | |
| - 30 | 0.200 at V _{GS} = - 10 V | - 2.0 | | |
| | 0.355 at V _{GS} = - 4.5 V | - 1.6 | | |

FEATURES

- Halogen-free According to IEC 61249-2-21
 Definition
- TrenchFET[®] Power MOSFET
- Compliant to RoHS Directive 2002/95/EC

APPLICATIONS

- Load Switch
 - Notebook PC
 - Servers



Marking Code

Ordering Information: Si1431DH-T1-E3 (Lead (Pb)-free) Si1431DH-T1-GE3 (Lead (Pb)-free and Halogen-free)

| Parameter | | Symbol | 5 s | Steady State | Unit |
|---|------------------------|-----------------------------------|-------------|--------------|------|
| Drain-Source Voltage | | V _{DS} | - 30 | | V |
| Gate-Source Voltage | | V _{GS} | ± 20 | | |
| Continuous Drain Current /T 150 °C)8 | T _A = 25 °C | – I _D | - 2.0 | - 1.7 | ۸ |
| Continuous Drain Current (T _J = 150 °C) ^a | T _A = 85 °C | | - 1.5 | - 1.2 | |
| Pulsed Drain Current | | I _{DM} | - 8 | | A |
| Continuous Diode Current (Diode Conduction) ^a | | ۱ _S | - 1.2 | - 0.8 | |
| Maximum Power Dissipation ^a | T _A = 25 °C | - P _D | 1.45 | 0.95 | W |
| | T _A = 85 °C | | 0.75 | 0.5 | |
| Operating Junction and Storage Temperature Range | | T _J , T _{stq} | - 55 to 150 | | °C |

| THERMAL RESISTANCE RATINGS | | | | | |
|--|--------------|-------------------|---------|---------|------|
| Parameter | | Symbol | Typical | Maximum | Unit |
| Maximum Junction-to-Ambient ^a | $t \le 5 s$ | R _{thJA} | 65 | 85 | |
| | Steady State | | 105 | 130 | °C/W |
| Maximum Junction-to-Foot (Drain) | Steady State | R _{thJF} | 40 | 50 | |

Note:

a. Surface mounted on 1" x 1" FR4 board.



COMPLIANT HALOGEN

Available

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| Parameter | Symbol | Test Conditions | Min. | Тур. | Max. | Unit |
|---|---------------------|---|------|--------|-------|------|
| Static | - | | | | | |
| Gate Threshold Voltage | V _{GS(th)} | $V_{DS} = V_{GS}, I_{D} = -100 \ \mu A$ | - 1 | | - 3 | V |
| Gate-Body Leakage | I _{GSS} | $V_{DS} = 0 V, V_{GS} = \pm 8 V$ | | | ± 100 | nA |
| Zero Gate Voltage Drain Current | I _{DSS} | $V_{DS} = -30 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$ | | | - 1 | ۵ |
| | | V_{DS} = - 30 V, V_{GS} = 0 V, T_{J} = 85 °C | | | - 5 | μA |
| On-State Drain Current ^a | I _{D(on)} | $V_{DS} = -5 V$, $V_{GS} = -4.5 V$ | - 4 | | | А |
| Drain-Source On-State Resistance ^a | R _{DS(on)} | V _{GS} = - 10 V, I _D = - 2.0 A | | 0.160 | 0.200 | |
| | | V _{GS} = - 4.5 V, I _D = - 1.6 A | | 0.285 | 0.355 | Ω |
| Forward Transconductance ^a | 9 _{fs} | V _{DS} = - 10 V, I _D = - 2.0 A | | 2 | | S |
| Diode Forward Voltage ^a | V _{SD} | I _S = - 1.2 A, V _{GS} = 0 V | | - 0.85 | - 1.2 | V |
| Dynamic ^b | | | | | | |
| Total Gate Charge | Qg | | | 2.4 | 4 | nC |
| Gate-Source Charge | Q _{gs} | V_{DS} = - 15 V, V_{GS} = - 4.5 V, I_{D} = - 2.0 A | | 0.8 | | |
| Gate-Drain Charge | Q _{gd} | | | 1.3 | | |
| Gate Resistance | Rg | f = 1.0 MHz | | 9 | | Ω |
| Turn-On Delay Time | t _{d(on)} | | | 55 | 80 | - ns |
| Rise Time | t _r | V_{DD} = - 15 V, R_L = 15 Ω | | 40 | 60 | |
| Turn-Off Delay Time | t _{d(off)} | $I_D \cong$ - 1 Å, V_{GEN} = - 10 V, R_g = 6 Ω | | 10 | 20 | |
| Fall Time | t _f | | | 10 | 20 | |

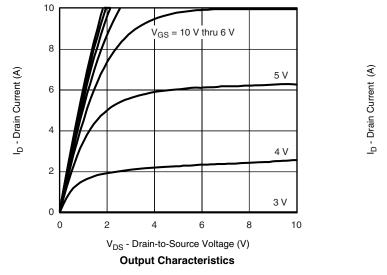
Notes:

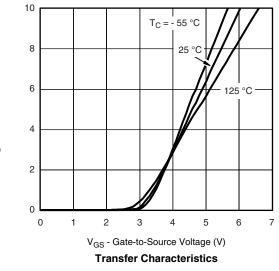
a. Pulse test; pulse width \leq 300 µs, duty cycle \leq 2 %.

b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

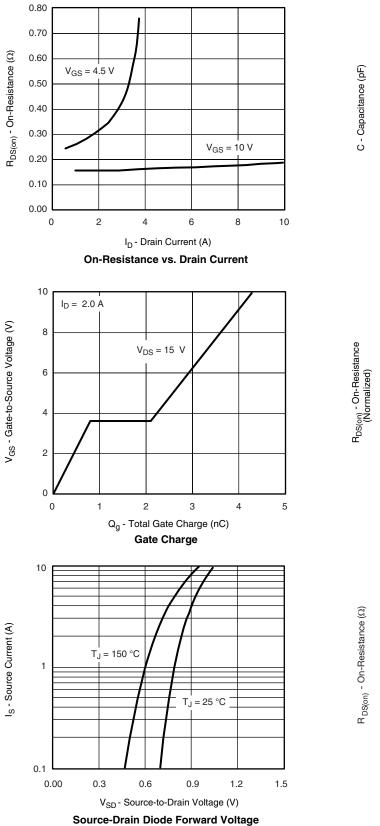


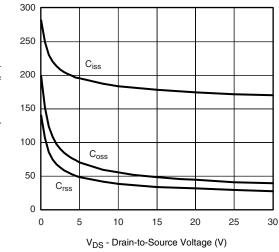




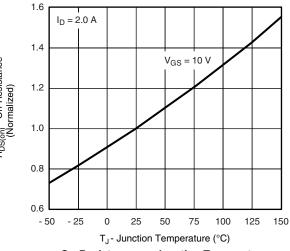
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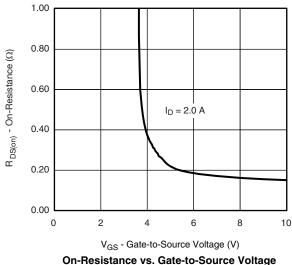




Capacitance



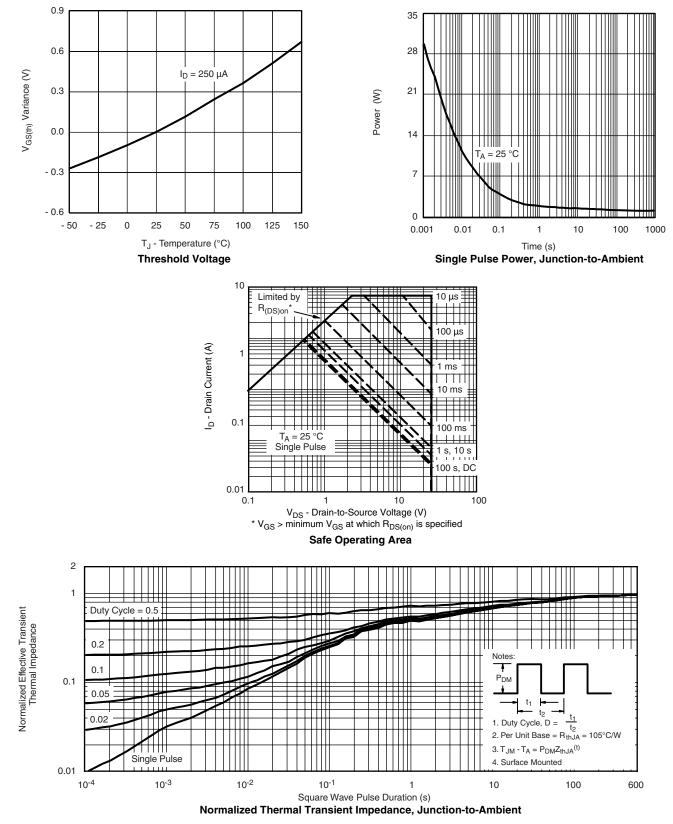
On-Resistance vs. Junction Temperature



Si1431DH

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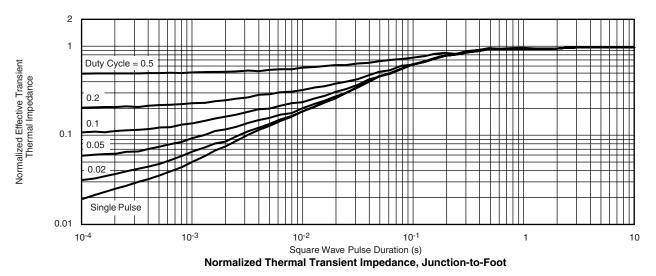






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TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see www.vishay.com/ppg272694.



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